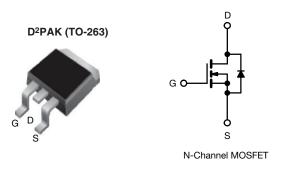
SiHB24N65EF



Vishay Siliconix

E Series Power MOSFET with Fast Body Diode



PRODUCT SUMMARY						
V _{DS} (V) at T _J max.	700					
R _{DS(on)} max. (Ω) at 25 °C	$V_{GS} = 10 V$	0.156				
Q _g max. (nC)	122					
Q _{gs} (nC)	17					
Q _{gd} (nC)	36					
Configuration	Single					

FEATURES

- Fast body diode MOSFET using E series technology
- Reduced t_{rr}, Q_{rr}, and I_{RRM}
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Low switching losses due to reduced Q_{rr}
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Telecommunications
 - Server and telecom power supplies
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Consumer and computing
 - ATX power supplies
- Industrial
 - Welding
 - Battery chargers
- Renewable energy
 - Solar (PV inverters)
- Switch mode power supplies (SMPS)
- Applications using the following topologies
 - LCC
 - Phase shifted bridge (ZVS)
 - 3-level inverter
 - AC/DC bridge

ORDERING INFORMATION	
Package	D ² PAK (TO-263)
Lead (Pb)-free and halogen-free	SiHB24N65EF-GE3
	SiHB24N65EFT1-GE3
	SIHB24N65EFT5-GE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	650	V
Gate-source voltage			V _{GS}	± 30	v
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C	- I _D -	24	
	V _{GS} at 10 V	T _C = 100 °C		15	A
Pulsed drain current ^a			I _{DM}	65	
Linear derating factor				2	W/°C
Single pulse avalanche energy b			E _{AS}	691	mJ
Maximum power dissipation			PD	250 W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope	T _J = 125 °C		d\//dt	70	
Reverse diode dV/dt ^d		dV/dt	50	V/ns	
Soldering recommendations (peak temperature) ^c	for	10 s		300	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 28.2 mH, $R_g = 25 \Omega$, $I_{AS} = 7$ A

c. 1.6 mm from case d. $I_{SD} \le I_D$, dI/dt = 900 A/µs, starting T_J = 25 °C

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1 For technical questions, contact: <u>hvm@vishay.com</u>



COMPLIANT

HALOGEN

FREE



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THERMAL RESISTANCE RA	TINGS						
PARAMETER	SYMBOL	TYP.	MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	-	62		°C/W		
Maximum junction-to-case (drain)	R _{thJC}	-	0.5				
SPECIFICATIONS (T _J = 25 $^{\circ}$ C	, unless otherwis	e noted)			-	-	
SPECIFICATIONS (T _J = 25 °C PARAMETER	, unless otherwis SYMBOL	e noted) TEST CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
		,	IONS	MIN.	TYP.	MAX.	UNIT
PARAMETER		,		MIN. 650	TYP.	MAX. -	UNIT

V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, $I_D = 1 \text{ mA}$		-	0.68	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	2	-	4	V	
Gate-source leakage	lasa	$V_{GS} = \pm 20 V$		-	-	± 100	nA
Gale-source leakage	I _{GSS}	$V_{GS} = \pm 30 \text{ V}$		-	-	± 1	μA
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 520 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1	μA
Zero gate voltage drain current	IDSS	V_{DS} = 520 V, V_{GS} = 0 V, T_J = 125 °C		-	-	500	
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 12 A	-	0.13	0.156	Ω
Forward transconductance	9 _{fs}	$V_{DS} = 30 \text{ V}, \text{ I}_{D} = 12 \text{ A}$		-	7.2	-	S
Dynamic							
Input capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 100 V,		-	2774	-	-
Output capacitance	C _{oss}			-	128	-	
Reverse transfer capacitance	C _{rss}		f = 1 MHz	-	4	-	_
Effective output capacitance, energy related ^a	C _{o(er)}	V_{DS} = 0 V to 520 V, V_{GS} = 0 V		-	96	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}			-	333	-	
Total gate charge	Qg			-	81	122	
Gate-source charge	Q _{gs}	$V_{GS} = 10 V$	$I_D = 12 \text{ A}, V_{DS} = 520 \text{ V}$	-	17	-	nC
Gate-drain charge	Q _{gd}			-	36	-	1
Turn-on delay time	t _{d(on)}			-	24	48	
Rise time	t _r	V _{DD} =	V _{DD} = 520 V, I _D = 12 A,		34	68	ns
Turn-off delay time	t _{d(off)}	$V_{GS}^{D} = 10 \text{ V}, \text{ R}_{g}^{D} = 9.1 \Omega$		-	80	120	
Fall time	t _f			-	46	92	
Gate input resistance	R _g	f = 1 MHz, open drain		0.2	0.5	1.0	Ω
Drain-Source Body Diode Characteristic	cs						
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	24	
Pulsed diode forward current	I _{SM}			-	-	65	A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 12 A, V _{GS} = 0 V		-	0.9	1.2	V
Reverse recovery time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S = 12 \text{ A}}, \\ dI/dt = 100 \text{ A}/\mu \text{s}, V_{R} = 400 \text{ V}$		-	151	288	ns
Reverse recovery charge	Q _{rr}			-	0.9	2.1	μC
Reverse recovery current	I _{RRM}			-	13	-	А

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

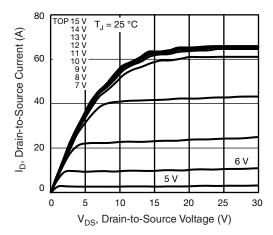


Fig. 1 - Typical Output Characteristics

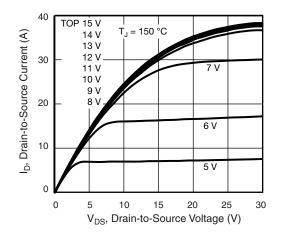


Fig. 2 - Typical Output Characteristics

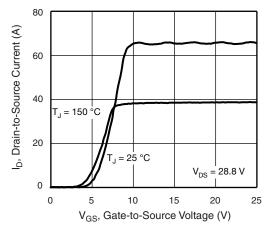


Fig. 3 - Typical Transfer Characteristics

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3 12 R_{DS(on)}, Drain-to-Source On Resistance (Normalized) 2.5 2 1.5 10 V 1 V_{GS} 0.5 0 - 60 - 40 - 20 60 80 100 120 140 160 0 20 40 T_J, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

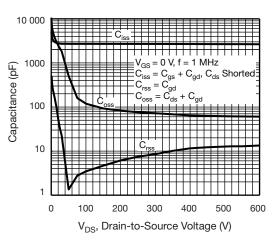
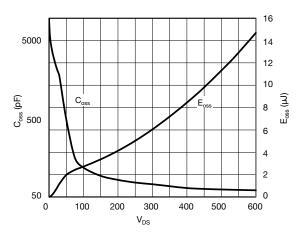
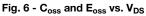
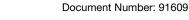


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage







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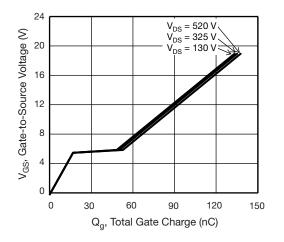


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

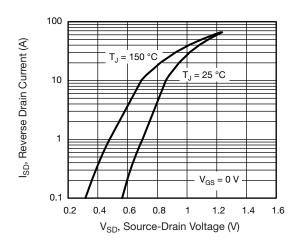


Fig. 8 - Typical Source-Drain Diode Forward Voltage

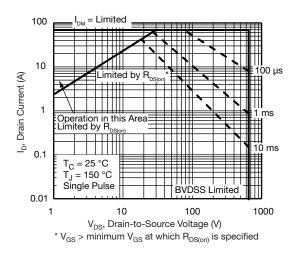


Fig. 9 - Maximum Safe Operating Area

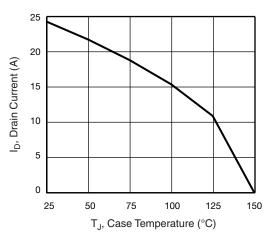


Fig. 10 - Maximum Drain Current vs. Case Temperature

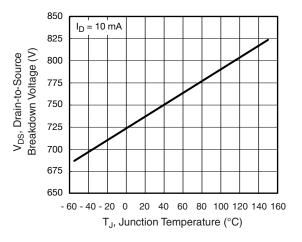
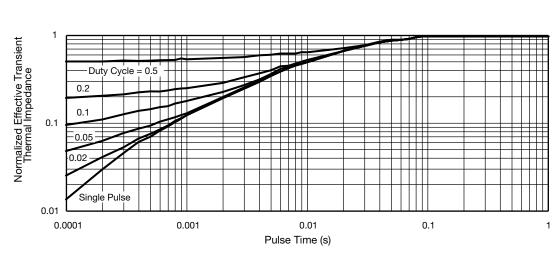
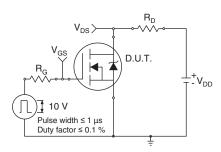


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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Fig. 13 - Switching Time Test Circuit

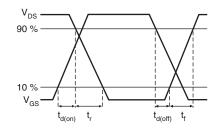
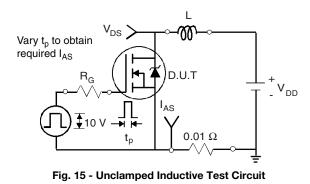


Fig. 14 - Switching Time Waveforms



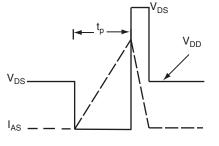


Fig. 16 - Unclamped Inductive Waveforms

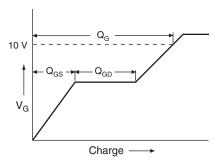
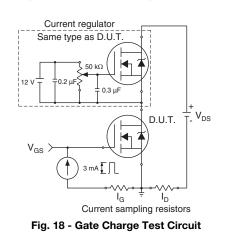


Fig. 17 - Basic Gate Charge Waveform



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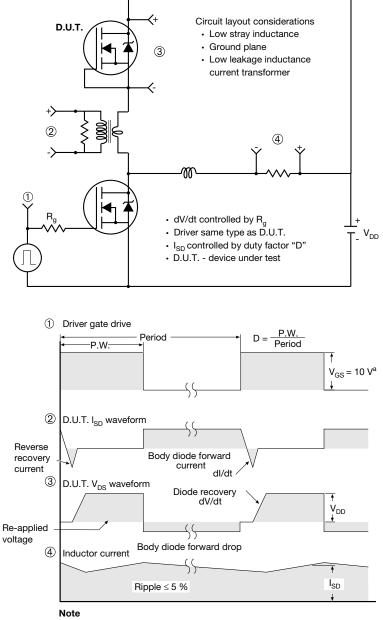
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 19 - For N-Channel

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